

5.15GHz TO 5.85GHz 802.11a/n

FRONT END MODULE

Package Style: QFN, 16-pin, 3.0 mmx3.0 mmx0.5 mm

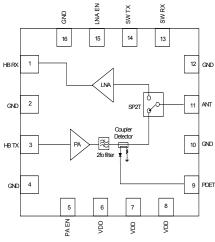


Features

- Single Supply Voltage 3.0V to 4.8V
- Integrated 5 GHz Amplifier, LNA, and SPT2T Tx/Rx Switch
- P_{OUT} = 15.5 dBm, 11a, OFDM at 2.5% EVM
- Low Height Package, Suited for SiP and CoB Designs

Applications

- Cellular handsets
- Mobile devices
- Tablets
- Consumer electronics
- Gaming
- Netbooks/Notebooks
- TV/monitors/video



Functional Block Diagram

Product Description

The RF5516 provides a complete integrated solution in a single Front-End Module (FEM) for WiFi 802.11a systems. The ultra small form factor and integrated matching minimizes the layout area in the customer's application and greatly reduces the number of external components to only one bypass capacitor for supply decoupling. This simplifies the total Front-End solution by reducing the bill of materials, system footprint, and manufacturability cost. The RF5516 integrates a Power Amplifier (PA), Single Pole Double Throw switch (SP2T), Low Noise Amplifier (LNA), and a power detector coupler for improved accuracy. The device is provided in a 3mmx3mmx0.5mm, 16-pin package. This module meets or exceeds the RF Front End needs of IEEE 802.11a WiFi RF systems.

Ordering Information

RF5516SB Standard 5 piece bag RF5516 Standard 25 piece bag RF5516SR Standard 100 piece bag RF5516TR7 Standard 2500 piece reel

RF5516PCK-410 Fully assembled Evaluation Board and 5 loose sample pieces

Optimum Technology Matching® Applied

∐ InGaP HBT	☐ GaAs HBT ☐ GaAs MESFET ☐ InGaP HBT	☐ SiGe BiCMOS ☐ Si BiCMOS ☐ SiGe HBT	☑ GaAs pHEMT ☐ Si CMOS ☐ Si BJT	☐ GaN HEMT
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RF5516



Absolute Maximum Ratings

Parameter	Rating	Unit
DC Supply Voltage	5.5	V _{DC}
Maximum TX and RX Input Power (No Damage)	5	dBm
Operating Temperature	-10 to +70	°C
Extreme Operating Temperature	-30 to +85	°C
Storage Temperature	-40 to +150	°C
Moisture Sensitivity	MSL2	



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

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Parameter	Specification			Unit	Condition
		Max.	Condition		
Transmit Parameters					Nominal conditions: T=25°C; V _{DD} =3.3V; PA_EN=3.0V; Freq=5.5GHz; 802.11a 54Mbps; pulsed at 1% to 99% duty cycle unless otherwise noted.
Compliance					IEEE802.11a/n; FCC CFR 15.45, .205, .209
Operating Frequency Range	5.15		5.85	GHz	
DC Supply Voltage	3.0	3.3	4.8	V	Nominal operating range 3.3V to 4.2V
PA Enable Voltage	2.80	3.0	3.6	V	
Output Power	14.5	15.5		dBm	Nominal conditions (Temp=25 °C; V _{DD} =3.3V; PA_EN=3.0V; Freq=5.5GHz)
	13	14		dBm	Over all conditions (Temp=-10 °C to +70 °C; V _{DD} =3.3V to 4.2V; PA_EN=2.8 V to 3.6V; Freq=5.1GHz to 5.85 GHz)
Operating Current		175	225	mA	P _{OUT} =15.5dBm 802.11a 54Mbps
Supply Leakage Currrent		10	50	μΑ	V _{DD} =3.6V; Control voltage LOW; PA_EN LOW
Error Vector Magnitude at Rated Power		2.5	3	%	P _{OUT} =15.5dBm 802.11a 54Mbps
Thermal Resistance		33		°C/W	V _{CC} =6, I _{CC} =140mA, T _{REF} =85°C
Harmonics					P _{OUT} =15.5dBm, 802.11a 6Mbps signal
2fo		-45	-42	dBm	
3fo		-45	-42	dBm	
Gain	28	32	34	dB	Temp = 25 ° C; V _{DD} = 3.3v; V _{REG} = 3.0V
	26	32	35.5	dB	Over all conditions (Temp=-10 °C to +70 °C; V _{DD} =3.3V to 4.2V; PA_EN=2.8V to 3.6V; Freq=5.15 GHz to 5.85 GHz)
Gain Variation	-2		2	dB	Over frequency per 100 MHz band
Ripple across band	-1		1	dB	Per 20MHz channel bandwidth
Power Detector Voltage	0.2		1.3	V	P _{OUT} =18dBm 802.11a 54Mbps
Receive Parameters					Unless otherwise stated, T=25°C, V _{DD} =3.3V, PAEN=0 V, SWTX=0 V, LNA_EN=3.0V, and SWRX=3.0V
Compliance					IEEE802.11a/n; FCC CFR 15.25, .205, .209
Frequency	5.15		5.85	GHz	
LNA Voltage Supply (V _{DD})	3.0		4.8	V	
Gain	8.5	11	14	dB	Over all nominal operating conditions
Noise Figure		2.8	4	dB	Over all nominal operating conditions



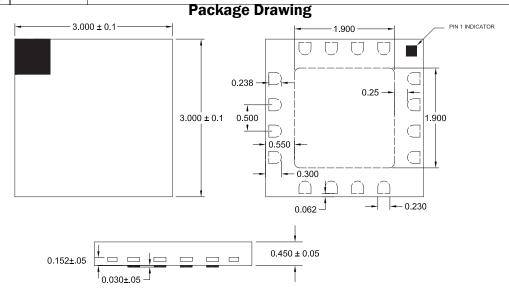
Parameter	Specification			Unit	Condition	
Min		Тур.	Max.	Ullit	Condition	
Receive Parameters, cont.						
Input IP3	+3	+5		dBm	Over all nominal operating conditions	
Input 1dB Compression	-5	-2.5		dBm		
Return Loss						
Input	3	5		dB	Freq=5.15 GHz to 5.85 GHz over temp and supply voltage	
Output	6.5	10		dB	Freq=5.15GHz to 5.85GHz over temp and supply voltage	
Passband Ripple	-0.5		+0.5	dB	In a 20 MHz channel	
LNA Current	4.5	10	15	mA	Over all nominal operating conditions	
RX to TX Isolation	20			dB		
Control Parameters						
Switch Control Logic HIGH	2.8		4.2	V	SWTX, SWRX	
Switch Control Logic LOW			0.2	V		
I _{CTRL-H}			30	μΑ		
I _{CTRL-L}			30	μΑ		
PA _{EN-H}	2.8	3.0	3.0	V		
PA _{EN-L}			0.2	V		
I _{PAEN}		2	3.5	mA		
LNA Enable Voltage (LNA_EN)	2.8	3.0	3.0	V	LNA enabled	
			0.2	V	LNA disabled	
Switch Speed			500	ns		

Logic Control Table

208.0 00.11.0. 145.0						
MODE	SWTX	SWRX	PA_EN	LNA_EN		
TRANSMIT	HIGH	LOW	HIGH	LOW		
RECEIVE	LOW	HIGH	LOW	HIGH		



Pin	Function	Description
1	HBRX	Receiver output. This port is DC blocked internally and matched to 50Ω .
2	GND	Ground connection.
3	НВТХ	Transmit RF input. This port is DC blocked internally and matched to 50Ω .
4	GND	Ground connection.
5	PA EN	Bias voltage for the PA. See logic control table for proper settings.
6	VDD1	Supply voltage for the LNA.
7	VDD2	Supply voltage for the PA.
8	VDD3	Same as pin 7.
9	PDET	Power detector for the transmit path.
10	GND	Ground connection.
11	ANT	Antenna port. Internally DC blocked and matched to 50Ω .
12	GND	Ground connection.
13	SWRX	Control switch for the receive mode. See logic control table for proper settings.
14	SWTX	Control switch for the transmit mode. See logic control table for proper settings.
15	LNA EN	Bias voltage for the LNA. See logic control table for proper settings.
16	GND	Ground connection.
Pkg Base	GND	The center metal base of the QFN package provides DC and RF ground as well as heat sink for the front-end module.

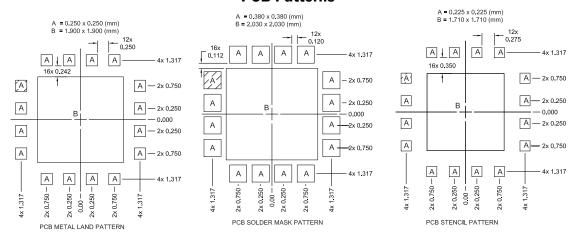


NOTES:

Shaded Area is Pin 1 Indicator



PCB Patterns

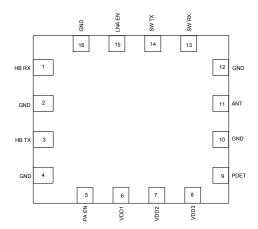


Thermal vias for center slug "B" should be incorporated into the PCB design. The number and size of the thermal vias will depend on the application, the power dissipation, and the electrical requirements. Example of the number and size of vias can be found on the RFMD evaluation board layout.

RF5516

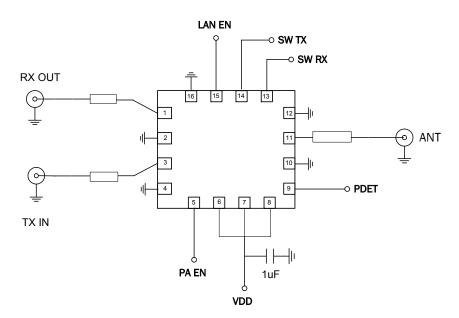


Pin Out





Application Schematic

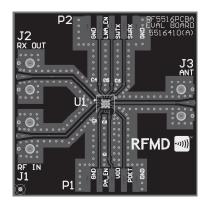




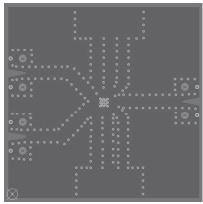
Evaluation Board Layout Board Size 1.5" x 1.5"

Board Thickness 0.044", Board Material RF-4

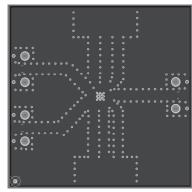
TOP SIGNAL



MID LAYER-2



MID LAYER-1



BOTTOM LAYER

